


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	AMS/18/11103	
1.3 Title of PCN	Assembly and Test & Finishing in subcontractor TSHT China for selected products in SO8 package	
1.4 Product Category	Selected SO8 package products from General Purpose and Analog Division (see product list)	
1.5 Issue date	2018-10-04	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	MARSHALL DAVE
2.1.2 Phone	
2.1.3 Email	dave.marshall@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Lorenzo NASO
2.1.2 Marketing Manager	Marcello SAN BIAGIO
2.1.3 Quality Manager	Jean-Marc BUGNARD

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	Subcontractor TSHT (China)

4. Description of change

	Old	New
4.1 Description	Assembly and Test & Finishing : - ST Shenzhen (China)	Assembly and Test & Finishing : - ST Shenzhen (China) - Subcontractor TSHT (China)
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The purpose of this change is to rationalize our manufacturing assets and provide a better support to our customers by enhancing the manufacturing process for higher volume production.
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	New finished good codes
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7. Timing / schedule

7.1 Date of qualification results	2018-12-15
7.2 Intended start of delivery	2019-01-15
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	11103 REL 6088-329-W-DLC-2018-LL02_TF75_to_TSHT -_.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2018-10-04

9. Attachments (additional documentations)

11103 Public product.pdf
11103 REL 6088-329-W-DLC-2018-LL02_TF75_to_TSHT - .pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	MC34063ABD-TR	
	ST485ECDR	

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